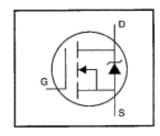
International Rectifier

IRFL014PbF

HEXFET® Power MOSFET

- Surface Mount
- · Available in Tape & Reel
- Dynamic dv/dt Rating
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

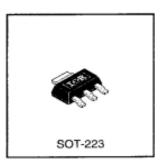


$$V_{DSS} = 60V$$
 $R_{DS(on)} = 0.20\Omega$
 $I_D = 2.7A$

Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infra red, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25W is possible in a typical surface mount application.



Absolute Maximum Ratings

	Parameter	Max.	Units	
ID @ Tc = 25°C Continuous Drain Current, Vgs @ 10 V		2.7		
@ T _C = 100°C Continuous Drain Current, V _{GS} @ 10 V		1.7	Α	
Грм	Pulsed Drain Current ①	22		
Pp @ Tc = 25°C	Power Dissipation	3.1	_ w	
PD @ TA = 25°C	Power Dissipation (PCB Mount)**	2.0		
	Linear Derating Factor	0.025	_ w/°c	
	Linear Derating Factor (PCB Mount)**	0.017		
V _{GS}	Gate-to-Source Voltage	±20	V	
Eas	Single Pulse Avalanche Energy 2	100	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	4.5	V/ns	
TJ, TSTG	Junction and Storage Temperature Range	-55 to +150	_ ∘c	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		

Thermal Resistance

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	Parameter	Min.	Тур.	Max.	Units
Reuc	Junction-to-PCB			40	°c/w
Reia	Junction-to-Ambient (PCB mount)**	_	_	60	٥,,,,

^{**} When mounted on 1" square PCB (FR-4 or G-10 Material).
For recommended footprint and soldering techniques refer to application note #AN-994.

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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
V _{(BR)OSS}	Drain-to-Source Breakdown Voltage	60		_	٧	V _{GS} =0V, I _D = 250μA	
ΔV _{(BR)DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient		0.068	_	V/°C	Reference to 25°C, Ip= 1mA	
R _{DS(on)}	Static Drain-to-Source On-Resistance	_	_	0.20	Ω	V _{GS} =10V, l _D =1.6A ®	
V _{GS(th)}	Gate Threshold Voltage	2.0	_	4.0	٧	V _{DS} =V _{GS} , I _D = 250μA	
9h	Forward Transconductance	1.9	_	mann	S	V _{0S} =25V, I ₀ =1.6A ⊕	
	Design to Source Lankage Current	_	_	25	μА	V _{DS} =60V, V _{GS} =0V	
loss	Drain-to-Source Leakage Current	_	_	250	μ.Α.	V _{DS} =48V, V _{GS} =0V, T _J =125°C	
Inne	Gate-to-Source Forward Leakage	_	_	100	nA	V _{GS} =20V	
lgss	Gate-to-Source Reverse Leakage			-100	1124	V _{GS} =-20V	
Qg	Total Gate Charge	_	_	11		I ₀ =10A	
Q _{gs}	Gate-to-Source Charge	_	_	3.1	nC	V _{DS} =48V	
Q _{gd}	Gate-to-Drain ("Miller") Charge	_	_	5.8		V _{GS} =10V See Fig. 6 and 13 @	
Td(on)	Turn-On Delay Time	_	10	_		V _{DD} =30V	
tr	Rise Time	_	50	_	ns	I _D =10A	
ta(orr)	Turn-Off Delay Time	_	13] ""	$R_G=24\Omega$	
tı	Fall Time	_	19	_		R ₀ =2.7Ω See Figure 10 ®	
Lo	Internal Drain Inductance	_	4.0	_	nН	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance		6.0		""	from package and center of die contact	
Ciss	Input Capacitance	anne	300	_		V _{GS} =0V	
Coss	Output Capacitance	_	160	_	pF	V _{DS} = 25V	
Crss	Reverse Transfer Capacitance	_	29	_		f=1.0MHz See Figure 5	

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)	-	_	2.7	_	MOSFET symbol showing the
Ism	Pulsed Source Current (Body Diode) ①	_	_	22	Α	integral reverse p-n junction diode.
V _{SO}	Diode Forward Voltage		_	1.6	٧	T _J =25°C, I _S =2.7A, V _{GS} =0V €
t _{rr}	Reverse Recovery Time	T-	70	140	ns	T _J =25°C, I _F =10A
Qrr	Reverse Recovery Charge		0.20	0.40	μC	di/dt=100A/μs ④
ton	Forward Turn-On Time	Intrinsi	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)			

Notes:

- Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ Isp≤10A, di/dt≤90A/µs, Vpp≤V(BR)pss, TJ≤150°C
- ② V_{DD}=25V, starting T_J=25°C, L=16mH R_G=25Ω, I_{AS}=2.7A (See Figure 12)
- ④ Pulse width ≤ 300 µs; duty cycle ≤2%.

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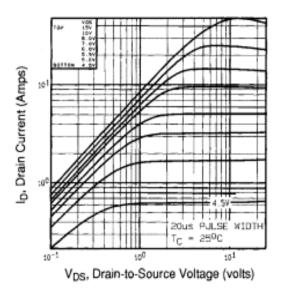


Fig 1. Typical Output Characteristics, Tc=25°C

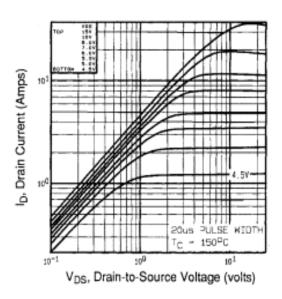


Fig 2. Typical Output Characteristics, T_C=150°C

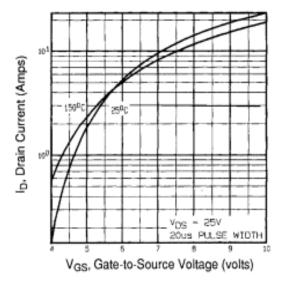


Fig 3. Typical Transfer Characteristics

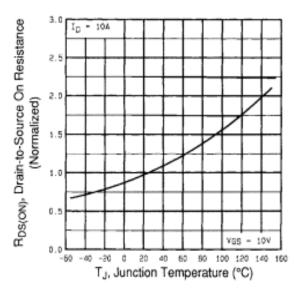


Fig 4. Normalized On-Resistance Vs. Temperature

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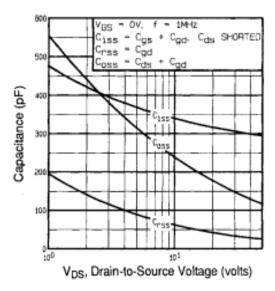


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

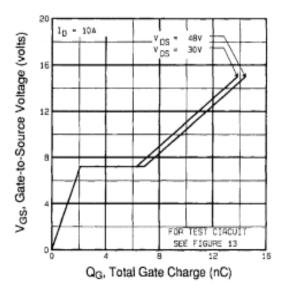


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

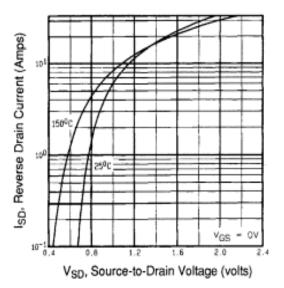


Fig 7. Typical Source-Drain Diode Forward Voltage

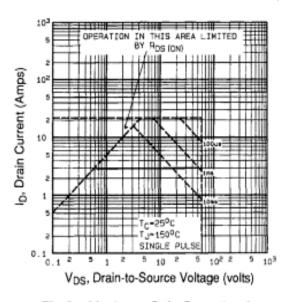


Fig 8. Maximum Safe Operating Area

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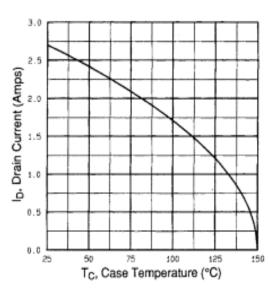


Fig 9. Maximum Drain Current Vs. Case Temperature

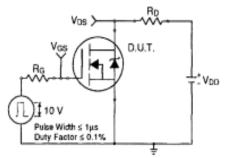


Fig 10a. Switching Time Test Circuit

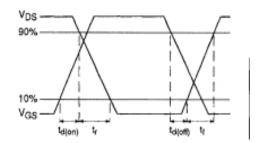
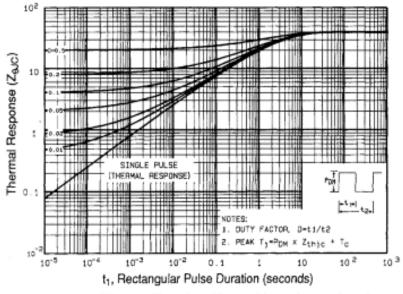


Fig 10b. Switching Time Waveforms



Maximum Effective Transient Thermal Impedance, Junction-to-Case

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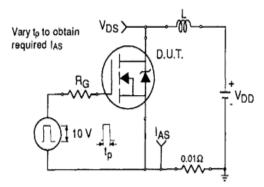


Fig 12a. Unclamped Inductive Test Circuit

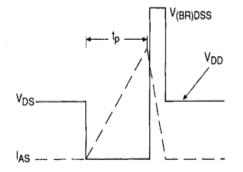


Fig 12b. Unclamped Inductive Waveforms

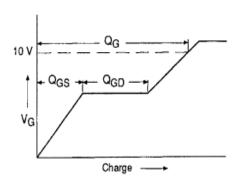


Fig 13a. Basic Gate Charge Waveform

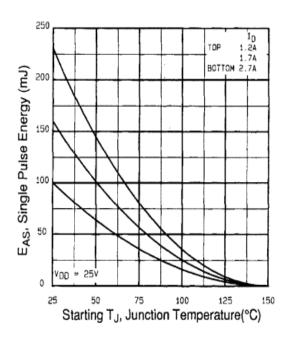


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

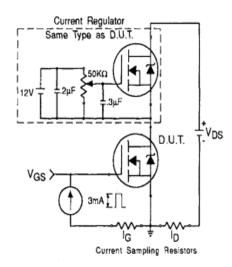
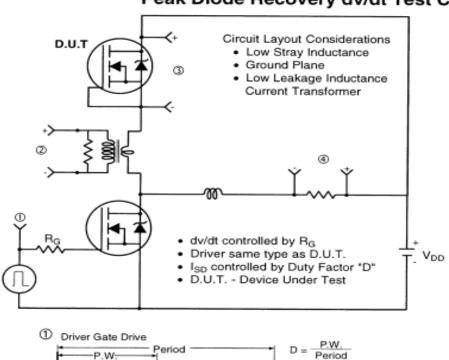
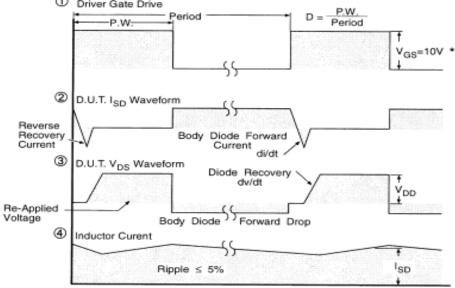


Fig 13b. Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit





* V_{GS} = 5V for Logic Level Devices

Fig 14. For N-Channel HEXFETS

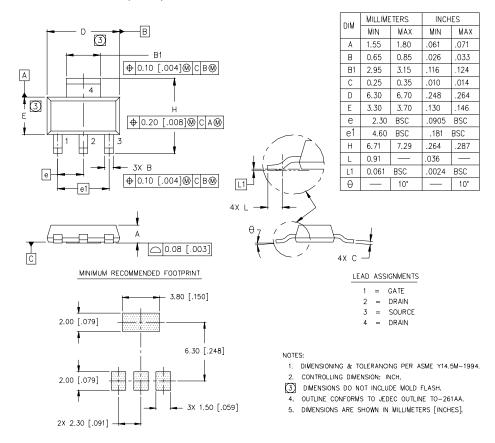
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SOT-223 (TO-261AA) Package Outline

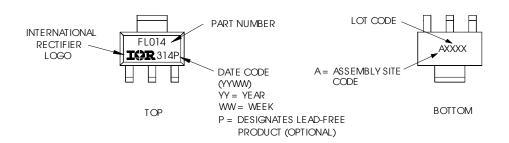
Dimensions are shown in milimeters (inches)



SOT-223 (TO-261AA) Part Marking Information

HEXFET PRODUCT MARKING

EXAMPLE: THIS IS AN IRFL014



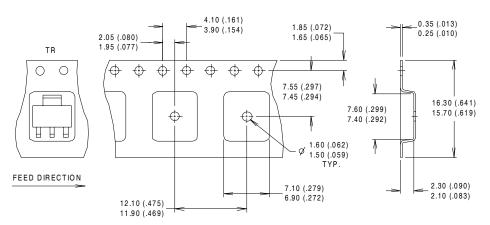
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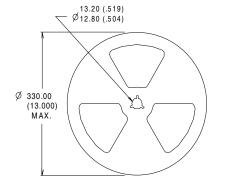
SOT-223 (TO-261AA) Tape & Reel Information

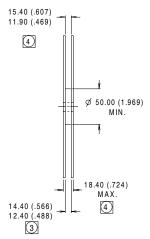
Dimensions are shown in milimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.
- 3. EACH $extstyled{0}$ 330.00 (13.00) REEL CONTAINS 2,500 DEVICES.





NOTES .

- OUTLINE COMFORMS TO EIA-418-1.
- CONTROLLING DIMENSION: MILLIMETER..
- DIMENSION MEASURED @ HUB.
 DINCLUDES FLANGE DISTORTION @ OUTER EDGE.

Data and specifications subject to change without notice.



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